CAN transceiver for 24 V systems

PCA82C251

FEATURES

- Fully compatible with the *"ISO 11898 - 24 V"* standard
- Slope control to reduce RFI
- Thermally protected
- Short-circuit proof to battery and ground in 24 V powered systems
- Low current standby mode
- An unpowered node does not disturb the bus lines
- At least 110 nodes can be connected
- High speed (up to 1 Mbaud)
- High immunity against electromagnetic interference.

GENERAL DESCRIPTION

The PCA82C251 is the interface between the CAN protocol controller and the physical bus. It is primarily intended for applications (up to 1 MBaud) in trucks and buses. The device provides differential transmit capability to the bus and differential receive capability to the CAN controller.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CC}	supply voltage		4.5	5.5	V
I_{CC}	supply current	standby mode	–	275	μA
$1/t_{bit}$	maximum transmission speed	non-return-to-zero	1	–	MBaud
V_{CAN}	CANH, CANL input/output voltage		–40	+40	V
V_{diff}	differential bus voltage		1.5	3.0	V
T_{amb}	operating ambient temperature		–40	+125	°C

ORDERING INFORMATION

TYPE NUMBER	PACKAGE		
	NAME	DESCRIPTION	CODE
PCA82C251	SO8	plastic small outline package; 8 leads body width 3.9 mm	SOT96-1
PCA82C251T	DIP8	plastic dual in-line package; 8 leads (300 mil)	SOT97-1

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BLOCK DIAGRAM

Fig.1 Block diagram.

PINNING

SYMBOL	PIN	DESCRIPTION
TXD	1	transmit data input
GND	2	ground
V_{CC}	3	supply voltage
RXD	4	receive data output
V_{ref}	5	reference voltage output
CANL	6	LOW level CAN voltage input/output
CANH	7	HIGH level CAN voltage input/output
Rs	8	slope resistor input

Fig.2 Pin configuration.

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FUNCTIONAL DESCRIPTION

The PCA82C251 is the interface between the CAN protocol controller and the physical bus. It is primarily intended for applications up to 1 MBaud in trucks and buses. The device provides differential transmit capability to the bus and differential receive capability to the CAN controller. It is fully compatible with the "ISO 11898-24 V" standard.

A current limiting circuit protects the transmitter output stage against short-circuit to positive and negative battery voltage. Although the power dissipation is increased during this fault condition, this feature will prevent destruction of the transmitter output stage.

If the junction temperature exceeds a value of approximately 160 °C, the limiting current of both transmitter outputs is decreased. Because the transmitter is responsible for the major part of the power dissipation, this will result in a reduced power dissipation and hence a lower chip temperature. All other parts of the IC will remain operating. The thermal protection is particularly needed when a bus line is short-circuited.

The CANH and CANL lines are also protected against electrical transients which may occur in an automotive environment.

Pin 8 (Rs) allows three different modes of operation to be selected, high-speed, slope control or standby.

For high-speed operation, the transmitter output transistors are simply switched on and off as fast as possible. In this mode, no measures are taken to limit the rise and fall slope. Use of a shielded cable is recommended to avoid RFI problems. The high-speed mode is selected by connecting pin 8 to ground.

The slope control mode allows the use of an unshielded twisted pair or a parallel pair of wires as bus lines. To reduce RFI, the rise and fall slope should be limited. The rise and fall slope can be programmed with a resistor connected from pin 8 to ground. The slope is proportional to the current output at pin 8.

If a logic HIGH level is applied to pin 8, the circuit enters a low current standby mode. In this mode, the transmitter is switched off and the receiver is switched to a low current. If dominant bits are detected (differential bus voltage >0.9 V), RXD will be switched to a LOW level.

The microcontroller should react to this condition by switching the transceiver back to normal operation (via pin 8). Because the receiver is slower in standby mode, the first message will be lost at higher bit rates.

Table 1 Truth table of the CAN transceiver

V_{CC}	TXD	CANH	CANL	BUS STATE	RXD
4.5 to 5.5 V	0	HIGH	LOW	dominant	0
4.5 to 5.5 V	1 (or floating)	floating	floating	recessive	1[2]
4.5 < V_{CC} < 5.5 V	X[1]	floating if V_{Rs} > 0.75V_{CC}	floating if V_{Rs} > 0.75V_{CC}	floating	1[2]
0 < V_{CC} < 4.5 V	floating	floating	floating	floating	X[1]

Notes

1. Where X = don't care.

2. If another bus node is transmitting a dominant bit, then RXD is logic 0.

Table 2 Pin Rs summary

CONDITION FORCED AT PIN Rs	MODE	RESULTING VOLTAGE OR CURRENT AT PIN Rs
V_{Rs} > 0.75V_{CC}	standby	$-I_{Rs}$ < 10 μA
10 μA < $-I_{Rs}$ < 200 μA	slope control	0.4V_{CC} < V_{Rs} < 0.6V_{CC}
V_{Rs} < 0.3V_{CC}	high-speed	$-I_{Rs}$ < 500 μA

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RATINGS

In accordance with the Absolute Maximum Rating System (IEC 134). All voltages are referenced to pin 2; positive input current.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CC}	supply voltage		−0.3	+7.0	V
V_n	DC voltage at pins 1, 4, 5 and 8	$0\ V < V_{CC} < 5.5\ V$,	−0.3	$V_{CC} + 0.3$	V
$V_{6,7}$	DC voltage on pins 6 and 7	no time limit	−40	+40	V
V_{tr}	transient voltage on pins 6 and 7	see Fig.8	−200	+200	V
T_{stg}	storage temperature		−55	+150	°C
T_{amb}	operating ambient temperature		−40	+125	°C
T_{vj}	virtual junction temperature	note 1	−40	+150	°C
V_{esd}	electrostatic discharge	note 2	−2500	+2500	V
		note 3	−250	+250	V

Note

1. In accordance with *"IEC 747-1"*.
   An alternative definition of virtual junction temperature T_{vj} is: $T_{vj} = T_{amb} + P_d \times R_{th\ vj\text{-}amb}$,
   where $R_{th\ vj\text{-}amb}$ is a fixed value to be used for the calculation of T_{vj}.
   The rating for T_{vj} limits the allowable combinations of power dissipation (P_d) and ambient temperature (T_{amb}).

2. Classification A: human body model; $C = 100\ pF$; $R = 1\,500\ \Omega$; $V = \pm2\,500\ V$.

3. Classification B: machine model; $C = 200\ pF$; $R = 0\ \Omega$; $V = \pm250\ V$.

QUALITY SPECIFICATION

Quality specification *"SNW-FQ-611 part E"* is applicable and can be found in the *"Quality reference pocket-book"* (ordering number 9398 510 34011).

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	VALUE	UNIT
$R_{th\ j\text{-}a}$	thermal resistance from junction to ambient in free air		
	SO8	160	K/W
	DIP8	100	K/W

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CHARACTERISTICS

V_{CC} = 4.5 to 5.5 V; T_{amb} = –40 to + 125 °C; R_L = 60 Ω; I_8 > –10 μA; unless otherwise specified.
All voltages referenced to ground (pin 2); positive input current; all parameters are guaranteed over the ambient
temperature range by design, but only 100% tested at +25 °C.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Supply						
I_3	supply current	dominant; V_1 = 1 V; V_{CC} < 5.1 V	–	–	78	mA
		dominant; V_1 = 1 V; V_{CC} < 5.25 V	–	–	80	mA
		dominant; V_1 = 1 V; V_{CC} < 5.5 V	–	–	85	mA
		recessive; V_1 = 4 V; R_8 = 47 kΩ	–	–	10	mA
		standby; note 1	–	–	275	μA
DC-bus transmitter						
V_{IH}	HIGH level input voltage	output recessive	0.7V_{CC}	–	V_{CC} + 0.3	V
V_{IL}	LOW level input voltage	output dominant	–0.3	–	0.3V_{CC}	V
I_{IH}	HIGH level input current	V_1 = 4 V	–200	–	+30	μA
I_{IL}	LOW level input voltage	V_1 = 1 V	100	–	600	μA
$V_{6,7}$	recessive bus voltage	V_1 = 4 V; no load	2.0	–	3.0	V
I_{LO}	off-state output leakage current	–2 V< (V_6,V_7) < 7 V	–2	–	+2	mA
		–5 V< (V_6,V_7) < 36 V	–10	–	+10	mA
V_7	CANH output voltage	V_1 = 1 V; V_{CC} = 4.75 to 5.5 V	3.0	–	4.5	V
		V_1 = 1 V; V_{CC} = 4.5 to 4.75 V	2.75	–	4.5	V
V_6	CANL output voltage	V_1 = 1 V	0.5	–	2.0	V
$\Delta V_{6,7}$	difference between output voltage at pins 6 and 7	V_1 = 1 V	1.5	–	3.0	V
		V_1 = 1 V; R_L = 45 Ω	1.5	–	–	V
		V_1 = 4 V; no load	–500	–	+50	mV
I_{sc7}	short-circuit CANH current	V_7 = –5 V	–	–	–200	mA
		V_7 = –36 V	–	–100	–	mA
I_{sc6}	short-circuit CANL current	V_6 = 36 V	–	–	200	mA
DC bus receiver [V_1 = 4 V; pins 6 and 7 externally driven; –2 V < (V6, V7) < 7 V; unless otherwise specified]						
$V_{diff(r)}$	differential input voltage (recessive)	note 2	–1.0	–	+0.5	V
		note 2; –7 V < (V_6, V_7) < 12 V	–1.0	–	+0.4	V
$V_{diff(d)}$	differential input voltage (dominant)		0.9	–	5.0	V
		–7 V < (V_6, V_7) < 12 V	1.0	–	5.0	V
		standby mode	0.97	–	5.0	V
		standby mode; V_{CC} = 4.5 to 5.25 V	0.91	–	5.0	V

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SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{diff(hys)}$	differential input hysteresis	see Fig.5	–	150	–	mV
V_{OH}	HIGH level output voltage (pin 4)	$I_4 = -100\ \mu A$	$0.8V_{CC}$	–	V_{CC}	V
V_{OL}	LOW level output voltage (pin 4)	$I_4 = 1$ mA	0	–	$0.2V_{CC}$	V
		$I_4 = 10$ mA	0	–	1.5	V
R_i	CANH, CANL input resistance		5	–	25	$k\Omega$
R_{diff}	differential input resistance		20	–	100	$k\Omega$
Reference output						
V_{ref}	reference output voltage	$V_8 = 1$ V; $I_5 < 50\ \mu A$	$0.45V_{CC}$	–	$0.55V_{CC}$	V
		$V_8 = 4$ V; $I_5 < 5\ \mu A$	$0.4V_{CC}$	–	$0.6V_{CC}$	V
Timing ($R_L = 60\ \Omega$; $C_L = 100$ pF; see Figs 3 and 4)						
t_{bit}	minimum bit time	$R_8 = 0\ \Omega$	–	–	1	μs
t_{onTXD}	delay TXD to bus active	$R_8 = 0\ \Omega$	–	–	50	ns
t_{offTXD}	delay TXD to bus inactive	$R_8 = 0\ \Omega$	–	40	80	ns
t_{onRXD}	delay TXD to receiver active	$R_8 = 0\ \Omega$	–	55	120	ns
t_{offRXD}	delay TXD to receiver inactive	$R_8 = 0\ \Omega$; $T_{amb} < +85\ ^\circ C$; $V_{CC} = 4.5$ to 5.1 V	–	80	150	ns
		$R_8 = 0\ \Omega$; $V_{CC} = 4.5$ to 5.1 V	–	80	170	ns
		$R_8 = 0\ \Omega$; $T_{amb} < +85\ ^\circ C$	–	90	170	ns
		$R_8 = 0\ \Omega$	–	90	190	ns
		$R_8 = 47\ k\Omega$	–	290	400	ns
t_{onRXD}	delay TXD to receiver active	$R_8 = 47\ k\Omega$	–	440	550	ns
$|SR|$	CANH, CANL slew rate	$R_8 = 47\ k\Omega$	–	7	–	V/μs
t_{WAKE}	wake-up time from standby (via pin 8)	see Fig.6	–	–	20	μs
t_{dRXDL}	bus dominant to RXD LOW	$V_8 = 4$ V; see Fig.7	–	–	3	μs
Standby/slope control (pin 8)						
V_{stb}	input voltage for standby mode		$0.75V_{CC}$	–	–	V
I_{slope}	slope control mode current		–10	–	–200	μA
V_{slope}	slope control mode voltage		$0.4V_{CC}$	–	$0.6V_{CC}$	V

Notes

1. $I_1 = I_4 = I_5 = 0$ mA; $0\ V < V_6 < V_{CC}$; $0\ V < V_7 < V_{CC}$; $V_8 = V_{CC}$; $T_{amb} < 90\ ^\circ C$.

2. This is valid for the receiver in all modes, high-speed, slope control and standby.

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TEST AND APPLICATION INFORMATION
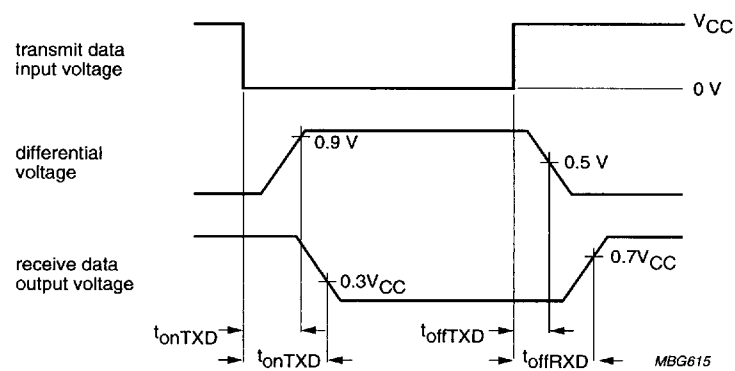

Fig.3 Test circuit for dynamic characteristics.

Fig.4 Timing diagram for dynamic characteristics.
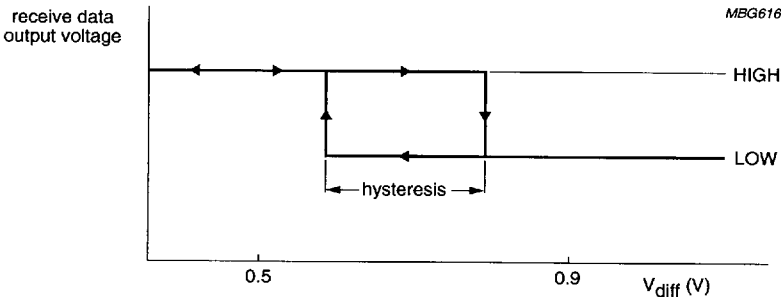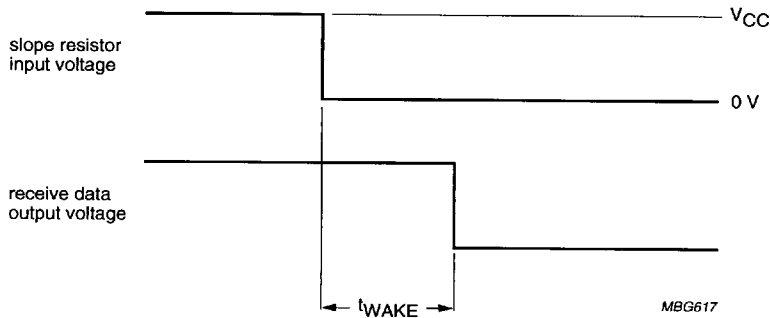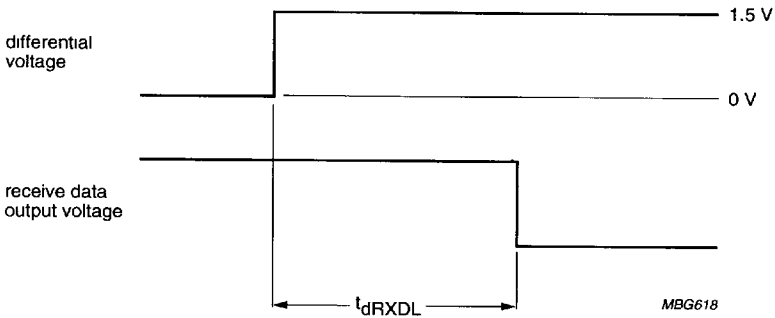
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Fig.5 Hysteresis.

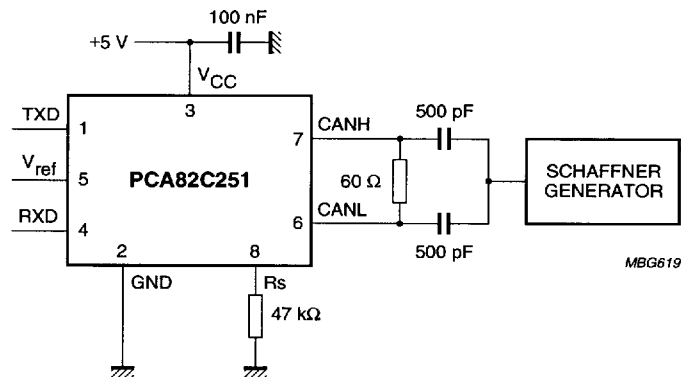$V_{TXD} = 1$ V.

Fig.6 Timing diagram for wake up from standby.

$V_{Rs} = 4$ V; $V_{TXD} = 4$ V.

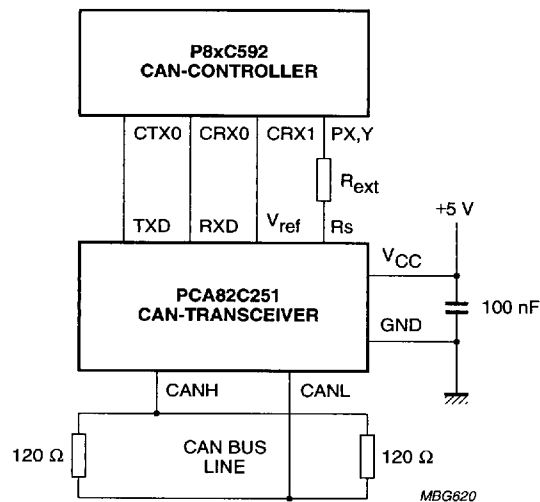Fig.7 Timing diagram for bus dominant to RXD low.

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The wave forms of the applied transients shall be in accordance with *ISO 7637 part 1*, test pulses 1, 2, 3a and 3b.

Fig.8 Test circuit for automotive transients.

(1) The output control register of the P8xC592 should be programmed to 1AH (push-pull operation, dominant = LOW)

(2) If no slope control is desired; $R_{ext} = 0$.
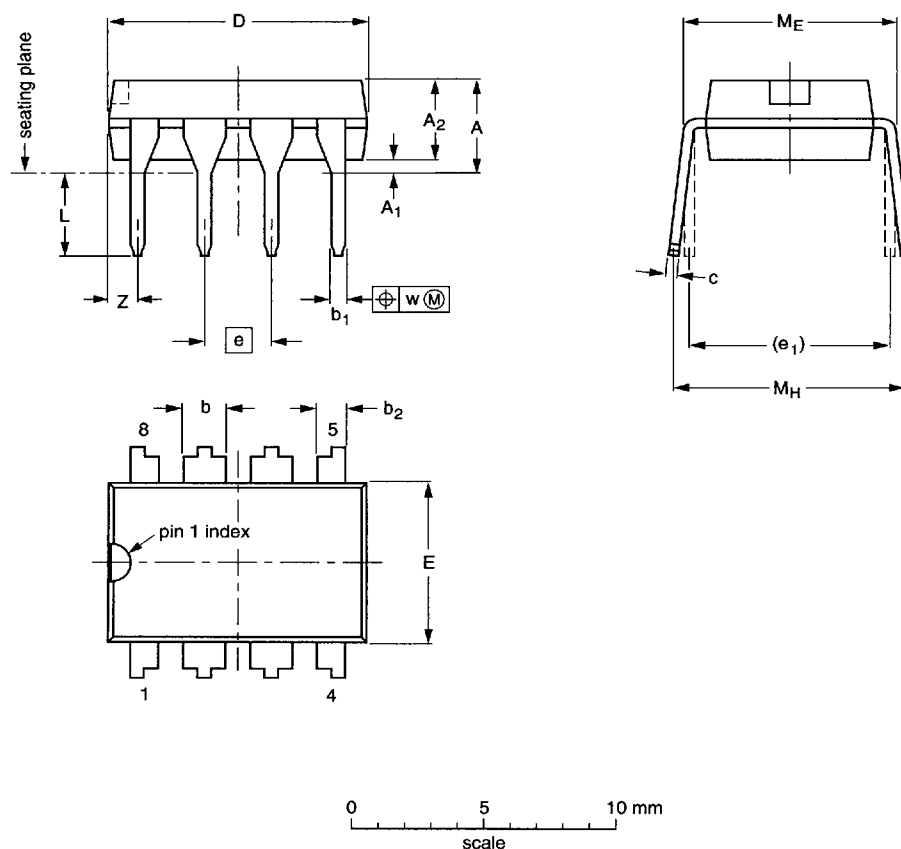
Fig.9 Application of the PCA82C251 CAN Transceiver.

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CAN transceiver for 24 V systems   PCA82C251

PACKAGE OUTLINES

DIP8: plastic dual in-line package; 8 leads (300 mil)   SOT97-1

DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A₁ min.	A₂ max.	b	b₁	b₂	c	D⁽¹⁾	E⁽¹⁾	e	e₁	L	M_E	M_H	w	Z⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.14	0.53 0.38	1.07 0.89	0.36 0.23	9.8 9.2	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	1.15
inches	0.17	0.020	0.13	0.068 0.045	0.021 0.015	0.042 0.035	0.014 0.009	0.39 0.36	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.045

UNIT	A max.	A_1 min.	A_2 max.	b	b_1	b_2	c	$D^{(1)}$	$E^{(1)}$	e	e_1	L	M_E	M_H	w	$Z^{(1)}$ max.
mm	4.2	0.51	3.2	1.73 / 1.14	0.53 / 0.38	1.07 / 0.89	0.36 / 0.23	9.8 / 9.2	6.48 / 6.20	2.54	7.62	3.60 / 3.05	8.25 / 7.80	10.0 / 8.3	0.254	1.15
inches	0.17	0.020	0.13	0.068 / 0.045	0.021 / 0.015	0.042 / 0.035	0.014 / 0.009	0.39 / 0.36	0.26 / 0.24	0.10	0.30	0.14 / 0.12	0.32 / 0.31	0.39 / 0.33	0.01	0.045

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT97-1	050G01	MO-001AN				~~92-11-17~~ 95-02-04

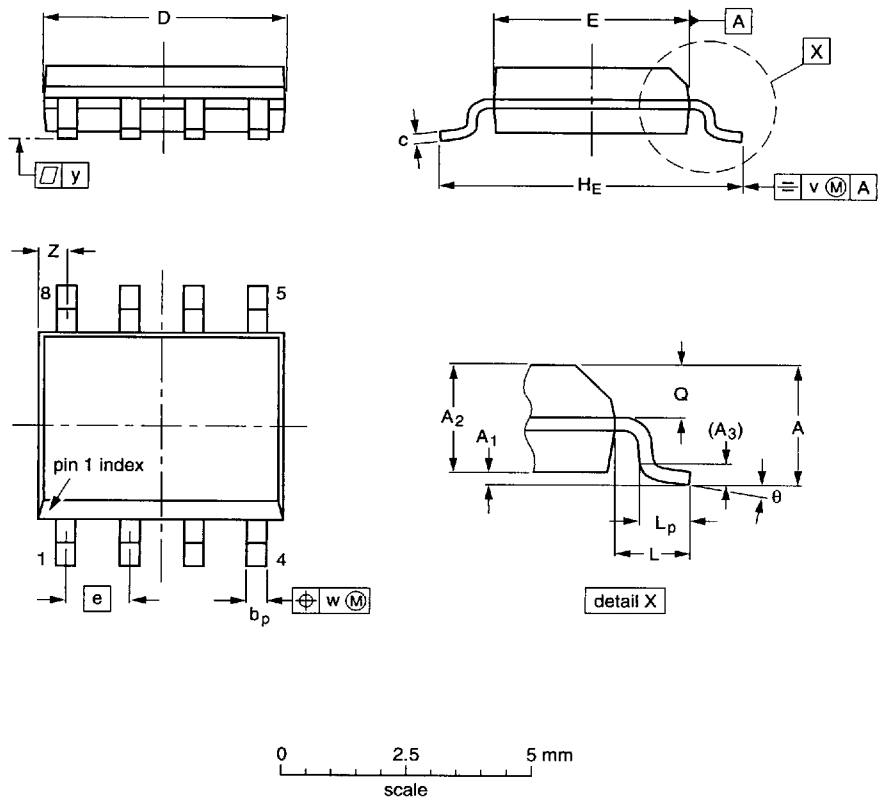1995 Oct 26   11

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CAN transceiver for 24 V systems   PCA82C251

SO8: plastic small outline package; 8 leads; body width 3.9 mm   **SOT96-1**


```
0        2.5        5 mm
|__|__|__|__|__|__|
         scale
```

DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A₁	A₂	A₃	bₚ	c	D(1)	E(2)	e	Hₑ	L	Lₚ	Q	v	w	y	Z(1)	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	5.0 4.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8° 0°
inches	0.069	0.0098 0.0039	0.057 0.049	0.01	0.019 0.014	0.0098 0.0075	0.20 0.19	0.16 0.15	0.050	0.24 0.23	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT96-1	076E03S	MS-012AA				~~92-11-17~~ 95-02-04

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CAN transceiver for 24 V systems

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SOLDERING

Introduction

There is no soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and surface mounted components are mixed on one printed-circuit board. However, wave soldering is not always suitable for surface mounted ICs, or for printed-circuits with high population densities. In these situations reflow soldering is often used.

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our *"IC Package Databook"* (order code 9398 652 90011).

DIP

SOLDERING BY DIPPING OR BY WAVE

The maximum permissible temperature of the solder is 260 °C; solder at this temperature must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds.

The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified maximum storage temperature ($T_{stg\ max}$). If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature within the permissible limit.

REPAIRING SOLDERED JOINTS

Apply a low voltage soldering iron (less than 24 V) to the lead(s) of the package, below the seating plane or not more than 2 mm above it. If the temperature of the soldering iron bit is less than 300 °C it may remain in contact for up to 10 seconds. If the bit temperature is between 300 and 400 °C, contact may be up to 5 seconds.

SO

REFLOW SOLDERING

Reflow soldering techniques are suitable for all SO packages.

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement.

Several techniques exist for reflowing; for example, thermal conduction by heated belt. Dwell times vary between 50 and 300 seconds depending on heating method. Typical reflow temperatures range from 215 to 250 °C.

Preheating is necessary to dry the paste and evaporate the binding agent. Preheating duration: 45 minutes at 45 °C.

WAVE SOLDERING

Wave soldering techniques can be used for all SO packages if the following conditions are observed:

- A double-wave (a turbulent wave with high upward pressure followed by a smooth laminar wave) soldering technique should be used.
- The longitudinal axis of the package footprint must be parallel to the solder flow.
- The package footprint must incorporate solder thieves at the downstream end.

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Maximum permissible solder temperature is 260 °C, and maximum duration of package immersion in solder is 10 seconds, if cooled to less than 150 °C within 6 seconds. Typical dwell time is 4 seconds at 250 °C.

A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

REPAIRING SOLDERED JOINTS

Fix the component by first soldering two diagonally-opposite end leads. Use only a low voltage soldering iron (less than 24 V) applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to 300 °C. When using a dedicated tool, all other leads can be soldered in one operation within 2 to 5 seconds between 270 and 320 °C.

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